

## 650V N-Channel Super Junction MOSFET

|         |       |       |        |
|---------|-------|-------|--------|
| Voltage | 650 V | Rdson | 140 mΩ |
| Current | 25 A  | Qg    | 48 nC  |

### Feature:

- $R_{DS(ON)}$  Max,  $V_{GS}@10V$  : 140mΩ
- Easy to use/driver
- High Speed Switching and Low  $R_{DS(ON)}$
- 100% Avalanche Tested
- 100% Rg Tested
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

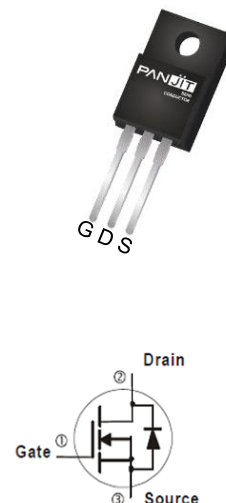
### Mechanical Data

- Case: ITO-220AB-F package
- Terminals: Solder able per MIL-STD-750, Method 2026
- Approx. Weight: 2 grams

### Application

- PFC, LED Power, PC Power, PD Charger, Adapter, UPS

ITO-220AB-F



## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

| PARAMETER                                        |                         | SYMBOL         | LIMIT    | UNITS            |
|--------------------------------------------------|-------------------------|----------------|----------|------------------|
| Drain-Source Voltage                             |                         | $V_{DS}$       | 650      | V                |
| Gate-Source Voltage                              |                         | $V_{GS}$       | $\pm 30$ |                  |
| Continuous Drain Current                         | $T_C=25^\circ\text{C}$  | $I_D$          | 25       | A                |
|                                                  | $T_C=100^\circ\text{C}$ |                | 15       |                  |
| Pulsed Drain Current                             | $T_C=25^\circ\text{C}$  | $I_{DM}$       | 75       | A                |
| Single Pulse Avalanche Energy (Note 6)           |                         | $E_{AS}$       | 180      | mJ               |
| MOSFET dv/dt ruggedness                          |                         | dv/dt          | 50       | V/ns             |
| Reverse diode dv/dt                              |                         | dv/dt          | 50       | V/ns             |
| Power Dissipation                                | $T_C=25^\circ\text{C}$  | $P_D$          | 69       | W                |
|                                                  | $T_C=100^\circ\text{C}$ |                | 28       |                  |
| Operating Junction and Storage Temperature Range |                         | $T_J, T_{STG}$ | -55~150  | $^\circ\text{C}$ |

### Thermal Characteristics

| PARAMETER          |                              | SYMBOL          | VALUES | UNITS              |
|--------------------|------------------------------|-----------------|--------|--------------------|
| Thermal Resistance | Junction-to-Case (Bottom)    | $R_{\theta JC}$ | 1.8    | $^\circ\text{C/W}$ |
|                    | Junction-to-Ambient (Note 3) | $R_{\theta JA}$ | 62.5   | $^\circ\text{C/W}$ |

**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise specified)

| PARAMETER                                                | SYMBOL       | TEST CONDITION                                                    | MIN. | TYP. | MAX.      | UNITS      |
|----------------------------------------------------------|--------------|-------------------------------------------------------------------|------|------|-----------|------------|
| <b>Static</b>                                            |              |                                                                   |      |      |           |            |
| Drain-Source Breakdown Voltage                           | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$                                         | 650  | -    | -         | V          |
| Gate Threshold Voltage                                   | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                                     | 3.0  | 4.0  | 5.0       |            |
| Drain-Source On-State Resistance                         | $R_{DS(on)}$ | $V_{GS}=10V, I_D=12\text{ A}^{(Note\ 1)}$                         | -    | 116  | 140       | m $\Omega$ |
| Zero Gate Voltage Drain Current                          | $I_{DSS}$    | $V_{DS}=650V, V_{GS}=0V$                                          | -    | -    | 10        | $\mu A$    |
| Gate-Source Leakage Current                              | $I_{GSS}$    | $V_{GS}=\pm 30V, V_{DS}=0V$                                       | -    | -    | $\pm 100$ | nA         |
| <b>Dynamic</b> (Note 5)                                  |              |                                                                   |      |      |           |            |
| Total Gate Charge                                        | $Q_g$        | $V_{DS}=480V, I_D=12A,$<br>$V_{GS}=0V\text{ to }10V$              | -    | 48   | -         | nC         |
| Gate-Source Charge                                       | $Q_{gs}$     |                                                                   | -    | 13.5 | -         |            |
| Gate-Drain Charge                                        | $Q_{gd}$     |                                                                   | -    | 21   | -         |            |
| Input Capacitance                                        | $C_{iss}$    | $V_{DS}=400V, V_{GS}=0V,$<br>$f=250KHz$                           | -    | 2032 | -         | pF         |
| Output Capacitance                                       | $C_{oss}$    |                                                                   | -    | 37   | -         |            |
| Reverse Transfer Capacitance                             | $C_{rss}$    |                                                                   | -    | 3.2  | -         |            |
| Effective Output Capacitance<br>Energy Related           | $C_{o(er)}$  | $V_{DS}=0V\text{ to }400V,$<br>$V_{GS}=0V,^{(Note\ 4)}$           | -    | 67   | -         | pF         |
| Turn-On Delay Time                                       | $t_{d(on)}$  | $V_{DD}=400V, I_D=12A,$<br>$V_{GS}=10V, R_g=25\Omega$<br>(Note 2) | -    | 53   | -         | ns         |
| Turn-On Rise Time                                        | $t_r$        |                                                                   | -    | 47   | -         |            |
| Turn-Off Delay Time                                      | $t_{d(off)}$ |                                                                   | -    | 156  | -         |            |
| Turn-Off Fall Time                                       | $t_f$        |                                                                   | -    | 25   | -         |            |
| Gate Resistance                                          | $R_g$        | $f=1.0MHz$                                                        | -    | 4.1  | -         | $\Omega$   |
| <b>Drain-Source Diode</b>                                |              |                                                                   |      |      |           |            |
| Maximum Continuous Drain-Source<br>Diode Forward Current | $I_S$        | $T_C=25^\circ\text{C}$                                            | -    | -    | 25        | A          |
| Diode Forward Voltage                                    | $V_{SD}$     | $I_S=12A, V_{GS}=0V$                                              | -    | 0.88 | -         | V          |
| Reverse Recovery Charge                                  | $Q_{rr}$     | $I_S=12A\quad di/dt=100A/\mu s$                                   | -    | 0.84 | -         | $\mu C$    |
| Reverse Recovery Time                                    | $T_{rr}$     |                                                                   | -    | 115  | -         | ns         |

NOTES :

1. Pulse width $\leq 300\mu s$ , Duty cycle $\leq 2\%$ .
2. Essentially independent of operating temperature typical characteristics.
3.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance.
4.  $C_{o(er)}$  is a capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0V to 400V.
5. Guaranteed by design, not subject to production testing.
6.  $E_{AS}$  is calculated based on the condition of  $L = 10\text{ mH}$ ,  $I_{AS} = 6A$ ,  $V_{DD} = 50\text{ V}$ ,  $V_{GS} = 10\text{ V}$ ,  $R_g=25\text{ohm}$ .

## TYPICAL CHARACTERISTIC CURVES

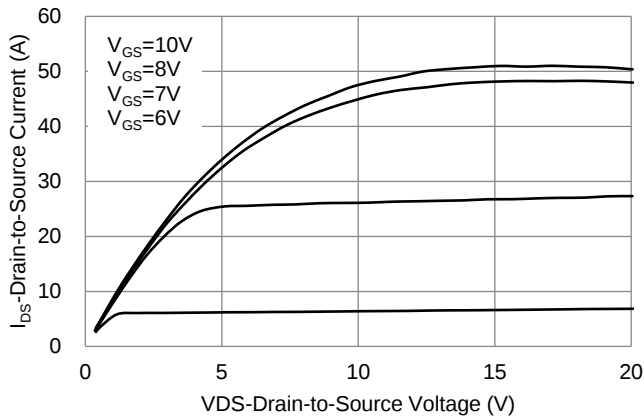


Fig.1 Output Characteristics

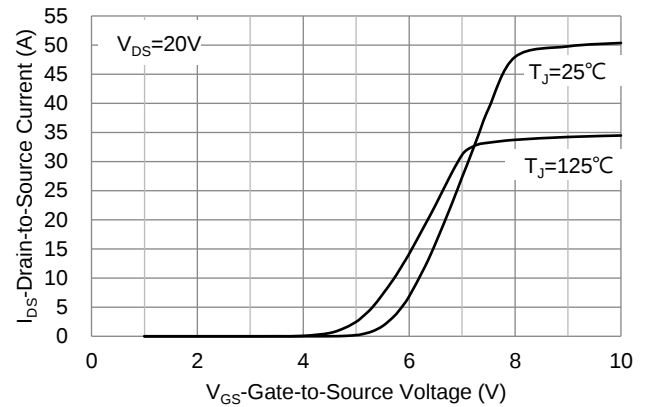


Fig.2 Transfer Characteristics

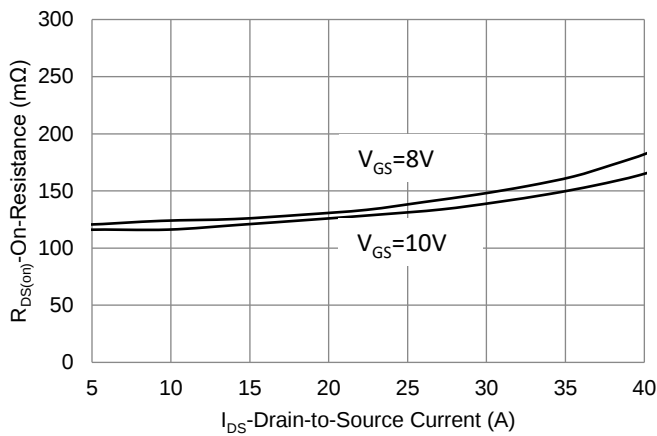


Fig.3 On-Resistance vs. Drain Current

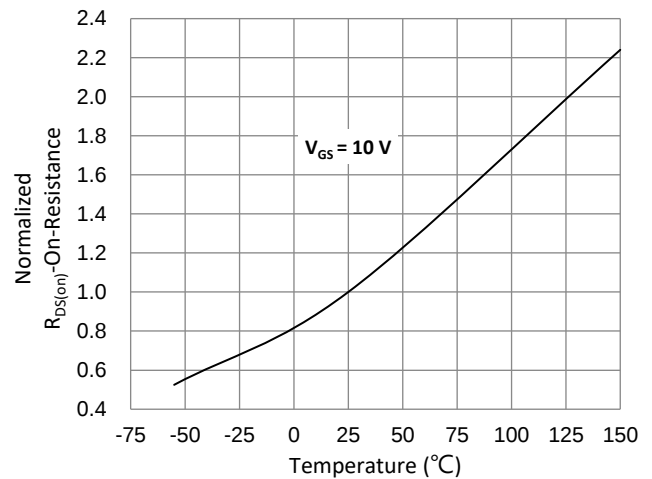


Fig.4 On-Resistance vs. Junction Temperature

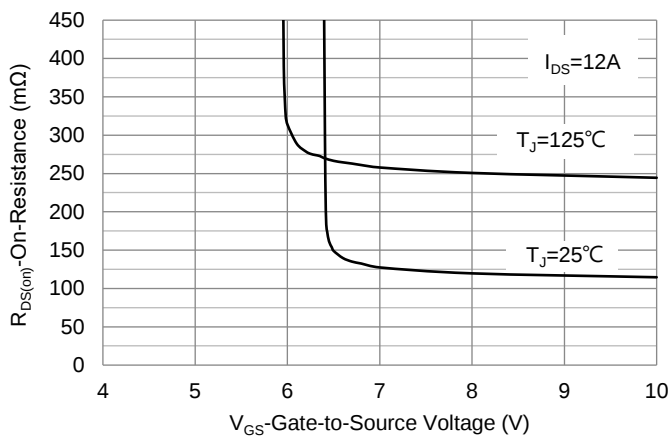


Fig.5 On-Resistance Variation with  $V_{GS}$

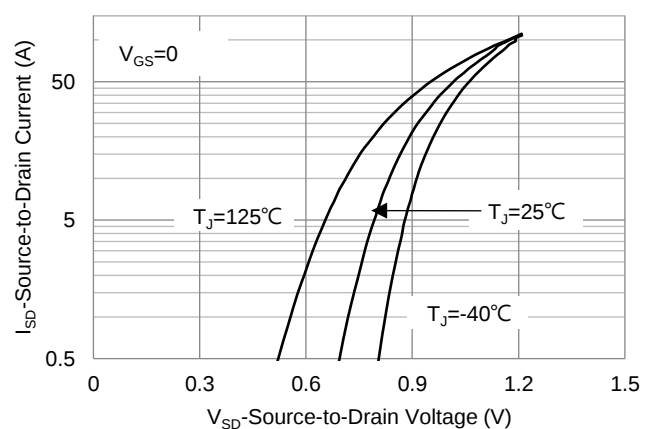


Fig.6 Body Diode Characteristics

## TYPICAL CHARACTERISTIC CURVES

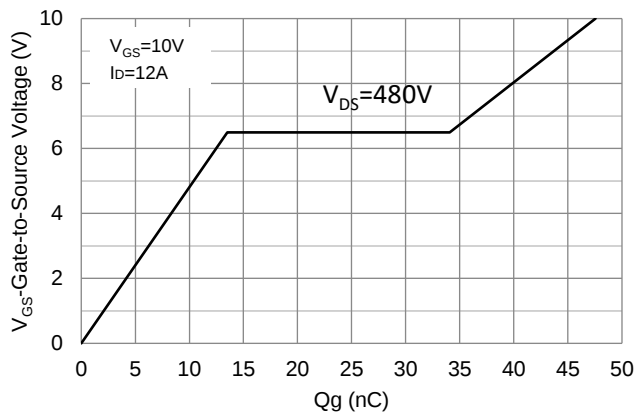


Fig.7 Gate-Charge Characteristics

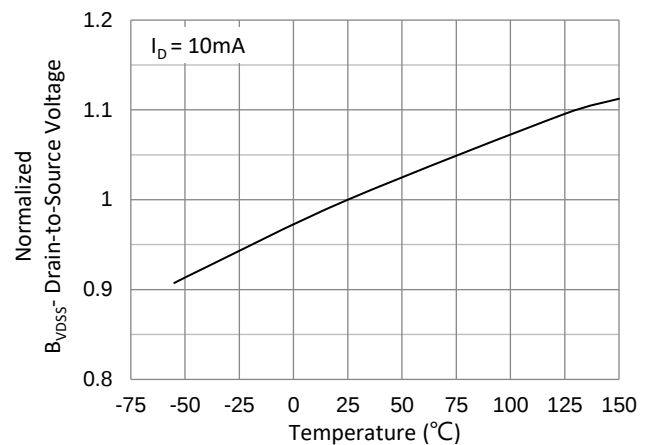


Fig.8 Breakdown Voltage Variation vs. Temperature

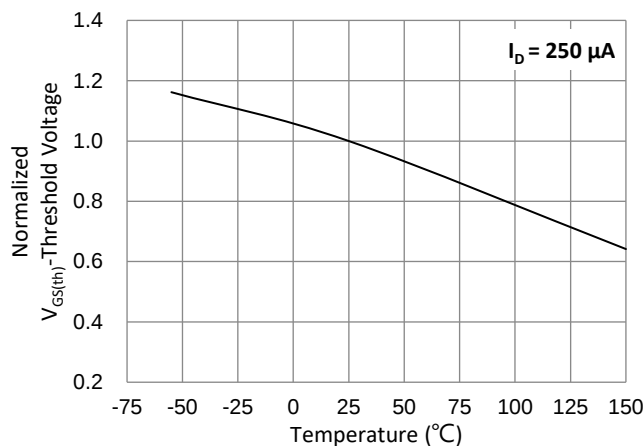


Fig.9 Threshold Voltage Variation with Temperature

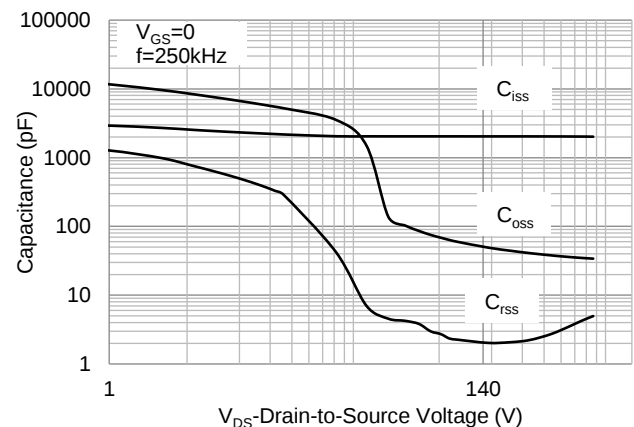


Fig.10 Typ.  $C_{oss}$  Stored Energy

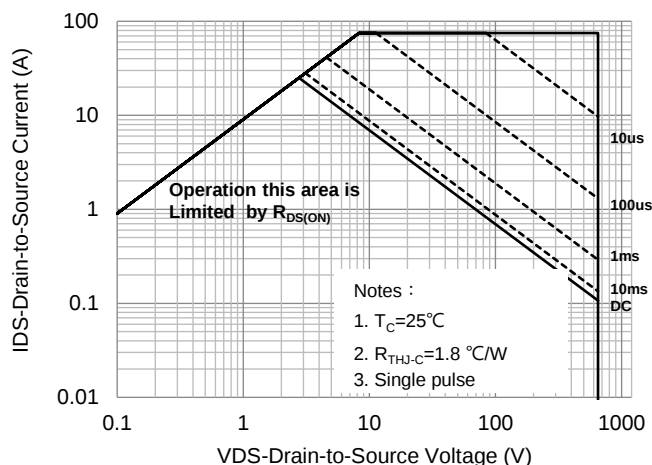


Fig.11 Maximum Safe Operating Area

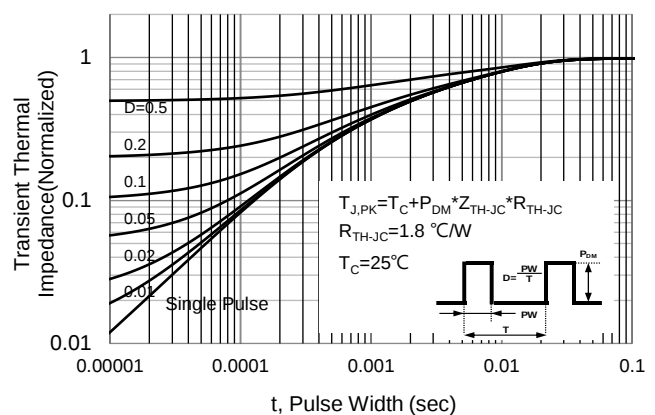


Fig.12 Normalized Transient Thermal Impedance

## TYPICAL CHARACTERISTIC CURVES

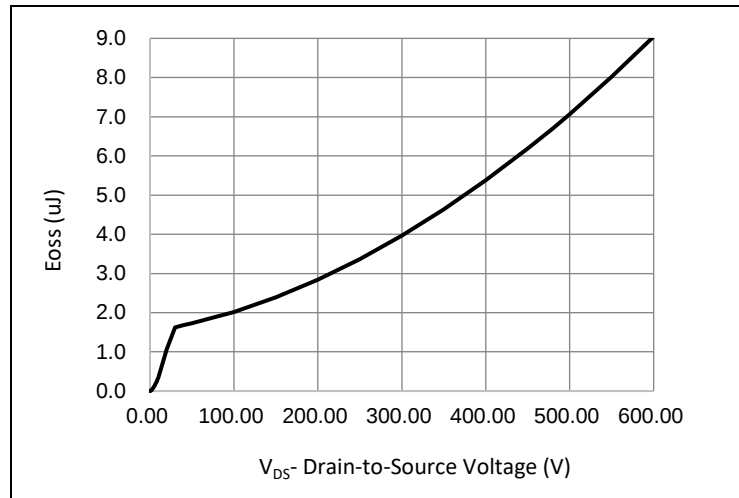
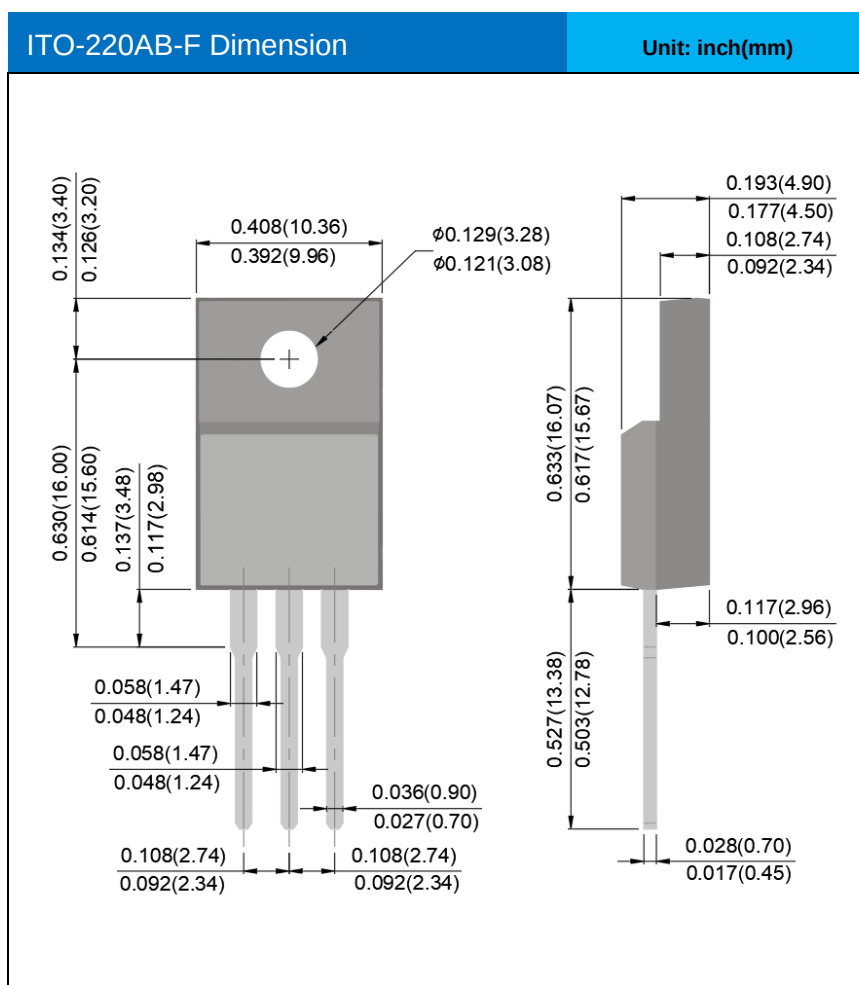


Fig.13 Typ. Coss Stored Energy

## Product and Packing Information

| Part No.       | Package Type | Packing Type | Marking  |
|----------------|--------------|--------------|----------|
| PDMF65R140FRC1 | ITO-220AB-F  | 50pcs / Tube | 65R140FC |

## Packaging Information



## Marking Diagram

|          |
|----------|
| PJ       |
| 65R140FC |
| YWLL x   |

**Y** = Year Code  
**W** = Week Code (A~Z)  
**LL** = Lot Code (00~99)  
**x** = Production Line Code

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